

To learn more about ON Semiconductor, please visit our website at
www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at _____



January 2013

®

FSEZ1317WA

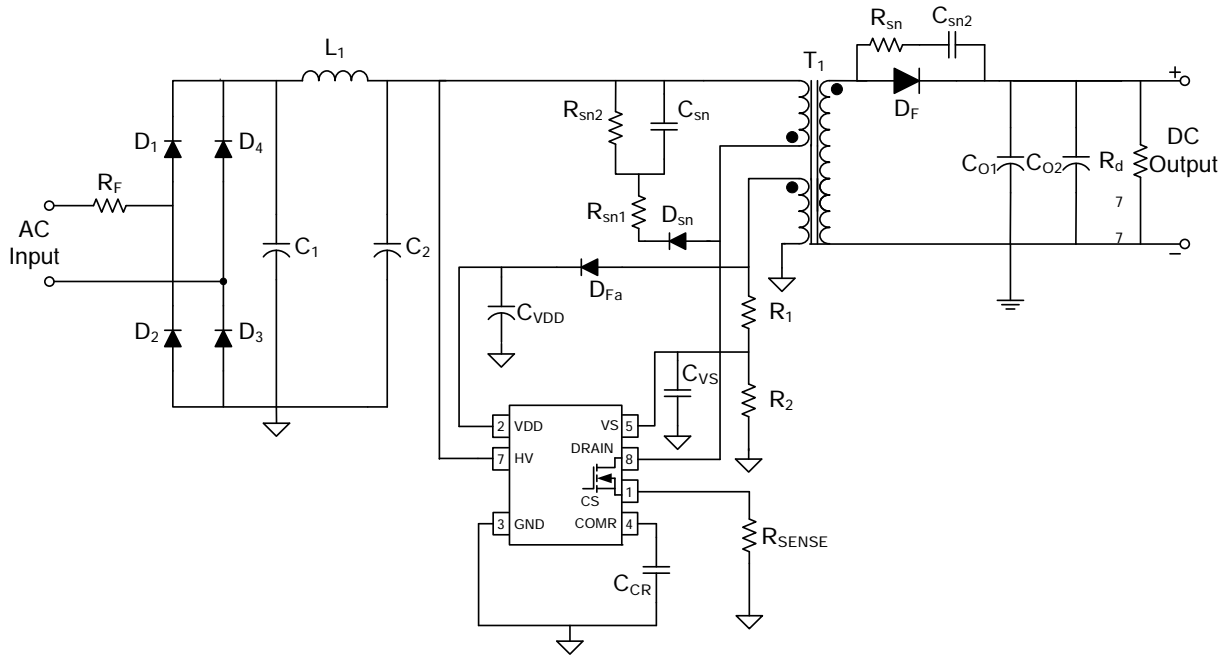
Primary-Side-Regulation PWM with POWER MOSFET Integrated

Features

- Low Standby Power Under 30 mW
- High-Voltage Startup
- Fewest External Component Counts
- Constant-Voltage (CV) and Constant-Current (CC) Control without Secondary-Feedback Circuitry
- Green-Mode: Linearly Decreasing PWM Frequency
- Fixed PWM Frequency at 50 kHz with Frequency

FSEZ1317WA — Primary-Side-Regulation PWM with POWER MOSFET Integrated

Application Diagram



FSEZ1317WA — Primary-Side-Regulation PWM with POWER MOSFET Integrated

Marking Information

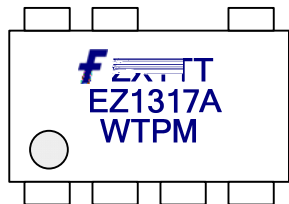


Figure 4. Top Mark

Pin Configuration

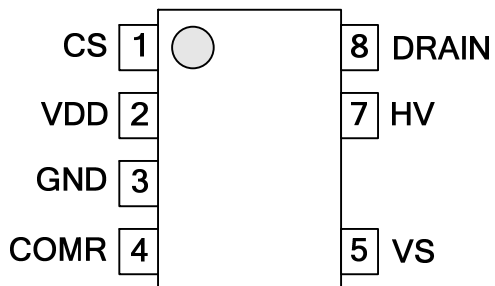
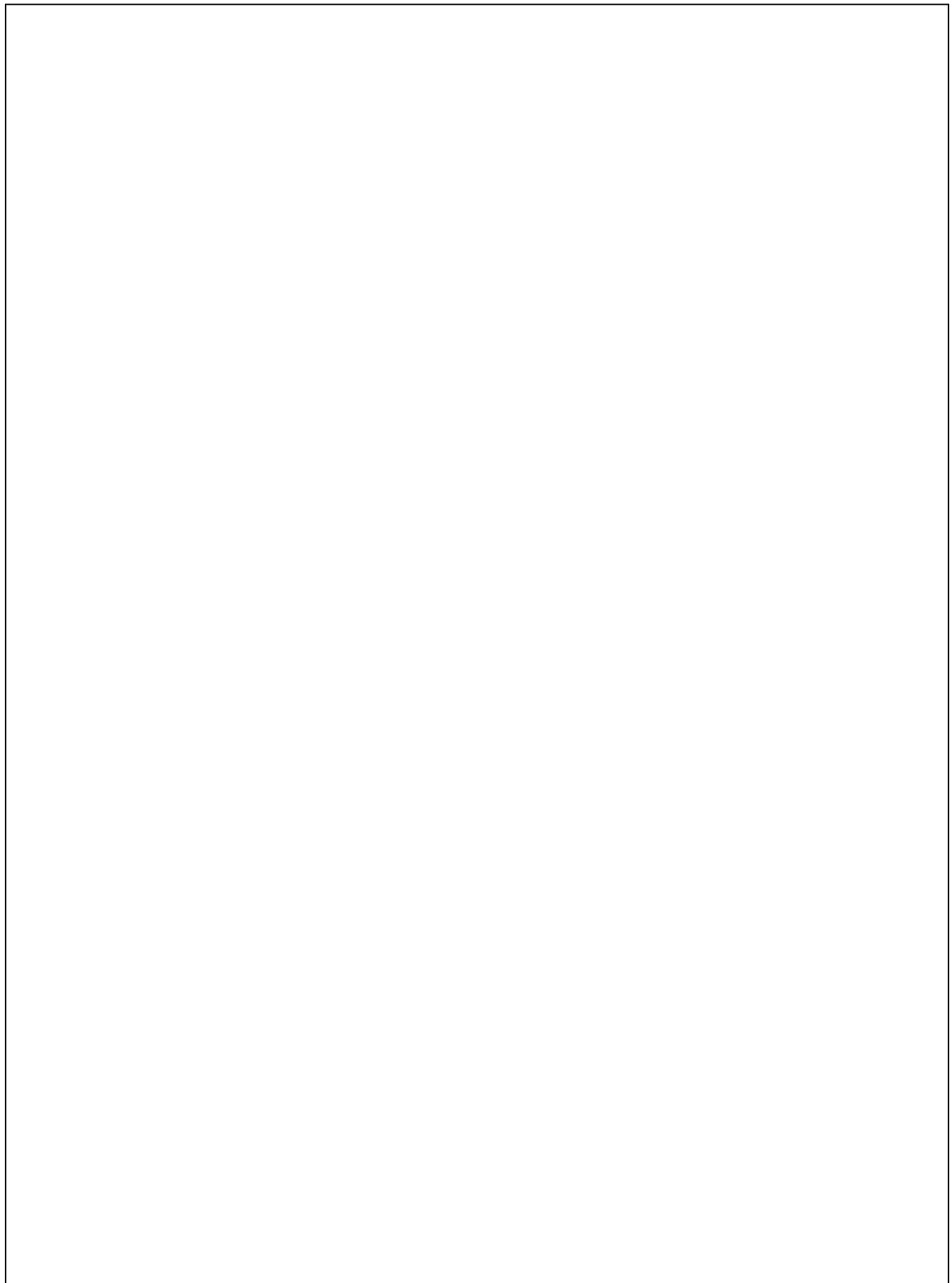


Figure 5. Pin Configuration

Pin Definitions

Pin #	Name	Description
-------	------	-------------



Electrical Characteristics

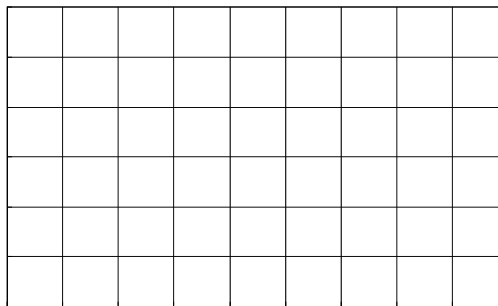
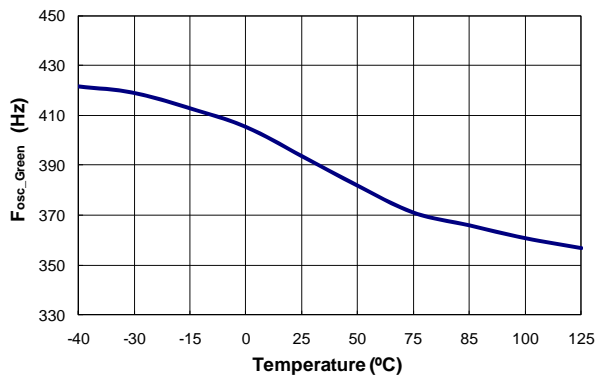
Unless otherwise specified, $V_{DD}=15\text{ V}$ and $T_A=25^\circ\text{C}$.

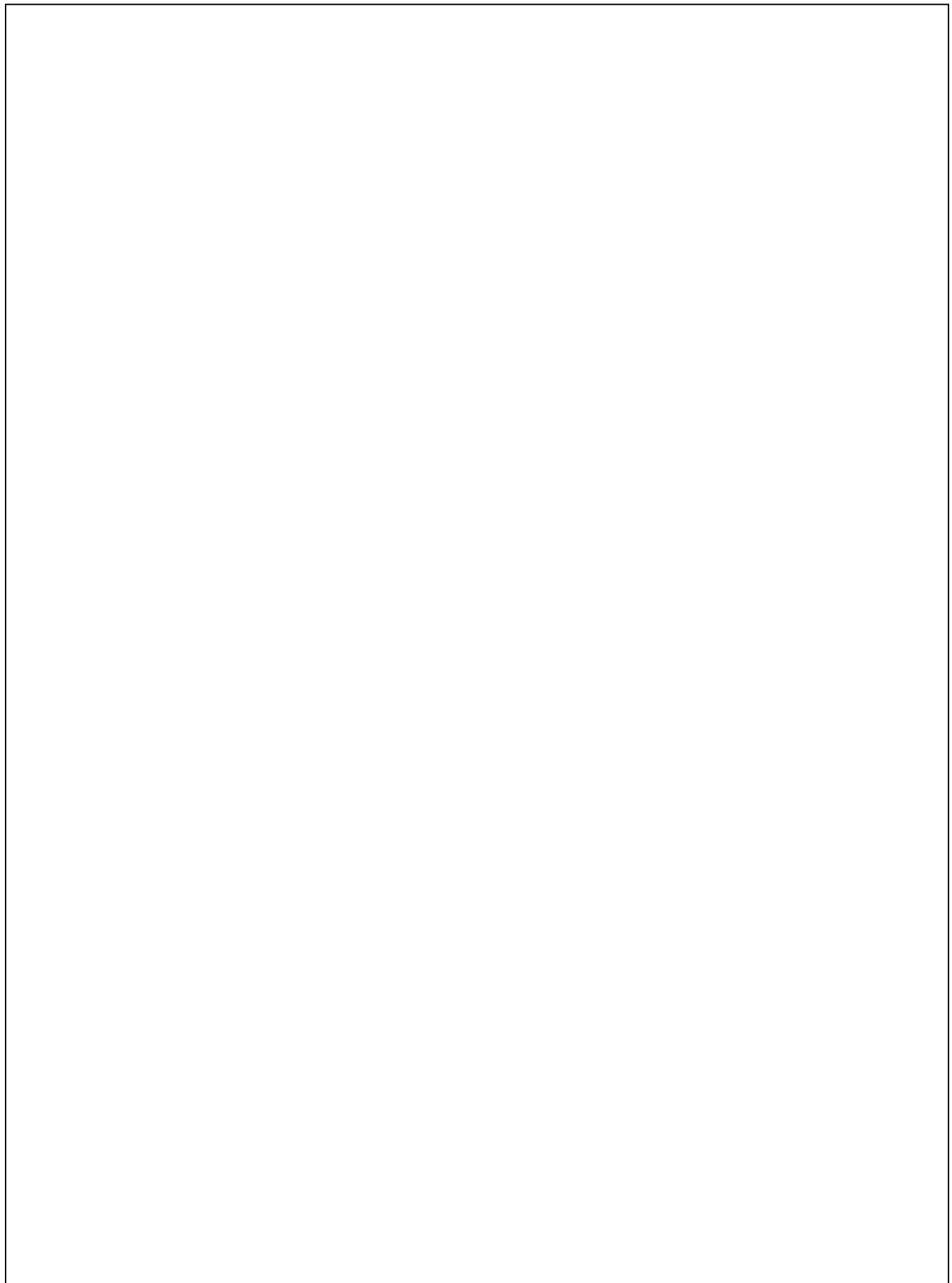
Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit	
V_{DD} Section							
V _{OP}	Continuously Operating Voltage				23	V	
V _{DD-ON}	Turn-On Threshold Voltage		15	16	17	V	
V _{DD-OFF}	Turn-Off Threshold Voltage		4.5	5.0	5.5	V	
I _{DD-OP}	Operating Current			2.5	5.0	mA	
I _{DD-GREEN}	Green-Mode Operating Supply Current			0.95	1.45	mA	
V _{DD-OVP}	V _{DD} Over-Voltage-Protection Level (OVP)			24		V	
V _{DD-OVP-HYS}	Hysteresis Voltage for V _{DD} OVP		1.5	2.0	2.5	V	
t _{D-VDDOVP}	V _{DD} Over-Voltage-Protection Debounce Time		50	200	300	μs	
HV Startup Current Source Section							
V _{HV-MIN}	Minimum Startup Voltage on HV Pin				50	V	
I _{HV}	Supply Current Drawn from HV Pin	V _{AC} =90 V (V _{DC} =100 V); V _{DD} =0 V		1.5	5.0	mA	
I _{HV-LC}	Leakage Current after Startup	HV=500 V, V _{DD} =V _{DD-OFF} +1 V		0.96	3.00	μA	
Oscillator Section							
f _{OSC}	Frequency	Center Frequency		47	50	53	kHz
		Frequency Hopping Range			±3.5		
f _{OSC-N-MIN}	Minimum Frequency at No-Load			370		Hz	

Hz R4 TmH 42.3 .42

Typical Performance CharacteristicsX

Typical Performance Characteristics (Continued)





Functional Description

Figure 24 shows the basic circuit diagram of primary-side regulated flyback converter, with typical waveforms shown in Figure 25. Generally, discontinuous conduction mode (DCM) operation is preferred for primary-side regulation because it allows better output regulation. The operation principles of DCM flyback converter are as follows:

During the MOSFET on time (t_{ON}), input voltage (V_{DL}) is applied across the primary-side inductor (L_m). Then MOSFET current (I_{ds}) increases linearly from zero to the peak value (I)

Cable Voltage Drop Compensation

In cellular phone charger applications, the battery is located at the end of cable, which typically causes

Under-Voltage Lockout (UVLO)

The turn-on and turn-off thresholds are fixed internally at 16 V and 5 V, respectively. During startup, the hold-up capacitor must be charged to 16V through the startup resistor to enable the FSEZ1317WA. The hold-up capacitor continues to supply V_{DD} until power can be delivered from the auxiliary winding of the main transformer. V_{DD} is not allowed to drop below 5 V during this startup process. This UVLO hysteresis window ensures that hold-up capacitor properly supplies V_{DD} during startup.

Protections

The FSEZ1317WA has several self-protection functions, such as Over-Voltage Protection (OVP), Over-Temperature Protection (OTP), and pulse-by-pulse current limit. All the protections are implemented as auto-restart mode. Once the abnormal condition occurs, the switching is terminated and the MOSFET remains off, causing V_{DD} to drop. When V_{DD} drops to the V_{DD} turn-off voltage of 5 V, internal startup circuit is enabled again and the supply current drawn from the HV pin charges the hold-up capacitor. When V_{DD} reaches the turn-on voltage of 16 V, normal operation resumes. In this manner, the auto-restart alternately enables and disables the switching of the MOSFET until the abnormal condition is eliminated (see Figure 29).

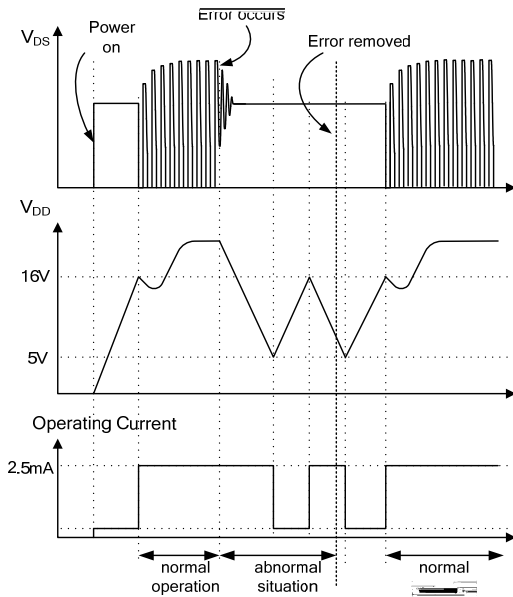


Figure 29. Auto-Restart Operation

V_{DD} Over-Voltage Protection (OVP)

V_{DD} over-voltage protection prevents damage from over-voltage conditions. If the V_{DD} voltage exceeds 24V at open-loop feedback condition, OVP is triggered and the PWM switching is disabled. The OVP has a debounce time (typically 200 μ s) to prevent false triggering due to switching noises.

Over-Temperature Protection (OTP)

The built-in temperature-sensing circuit shuts down PWM output if the junction temperature exceeds 140°C.

Pulse-by-pulse Current Limit

When the sensing voltage across the current-sense resistor exceeds the internal threshold of 0.8 V, the MOSFET is turned off for the remainder of switching cycle. In normal operation, the pulse-by-pulse current limit is not triggered since the peak current is limited by the control loop.

Leading-Edge Blanking (LEB)

Each time the power MOSFET switches on, a turn-on spike occurs at the sense resistor. To avoid premature termination of the switching pulse, a leading-edge blanking time is built in. During this blanking period, the current-limit comparator is disabled and cannot switch off the gate driver. As a result conventional RC filtering can be omitted.

Gate Output

The FSEZ1317WA output stage is a fast totem-pole gate driver. Cross conduction has been avoided to minimize heat dissipation, increase efficiency, and enhance reliability. The output driver is clamped by an internal 15 V Zener diode to protect the power MOSFET transistors against undesired over-voltage gate signals.

Built-In Slope Compensation

The sensed voltage across the current-sense resistor is used for current mode control and pulse-by-pulse current limiting. Built-in slope compensation improves stability and prevents sub-harmonic oscillations due to peak-current mode control. The FSEZ1317WA has a synchronized, positive-slope ramp built-in at each switching cycle.

Noise Immunity

Noise from the current sense or the control signal can cause significant pulsewidth jitter, particularly in continuous-conduction mode. While slope compensation helps alleviate their effects, the FSEZ1317WA has a built-in noise immunity feature that helps maintain stable operation. The FSEZ1317WA has a built-in noise immunity feature that helps maintain stable operation. The FSEZ1317WA has a built-in noise immunity feature that helps maintain stable operation.

Typical Application Circuit (Primary-Side Regulated Flyback Charger)

Application	Fairchild Devices	Input Voltage Range	Output	Output DC cable
Cell Phone Charger	FSEZ1317WA	90~265 V _{AC}	5V/0.7 A (3.5 W)	AWG26, 1.8 Meter

Features

- High efficiency (>65.5% at full load) meeting EPS 2.0 regulation with enough margin.
- Low standby (P_{in}<30 mW at no-load condition).

230V_{AC} 60Hz(

----- (%)

Typical Application Circuit (Continued)

Transformer Specification

- Core: EE16
- Bobbin: EE16

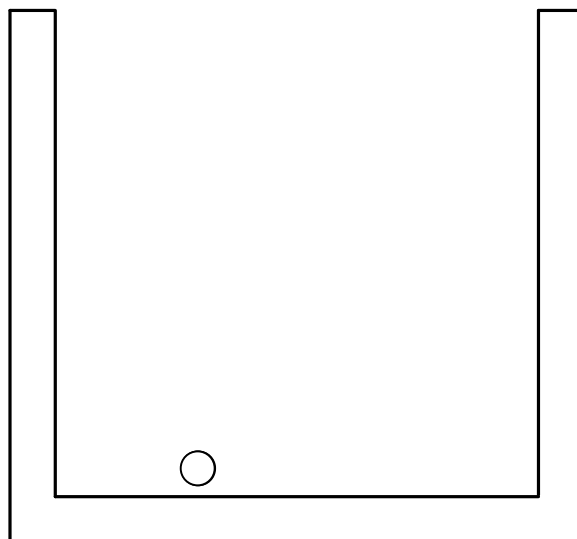


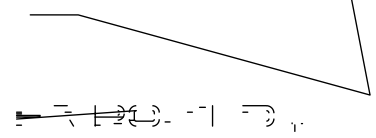
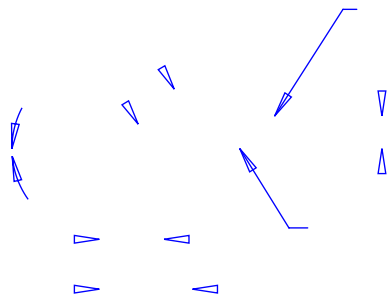
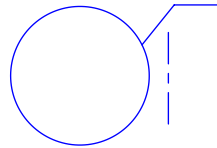
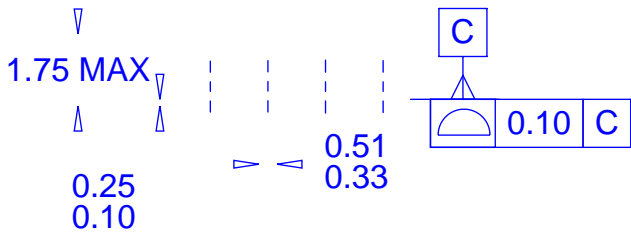
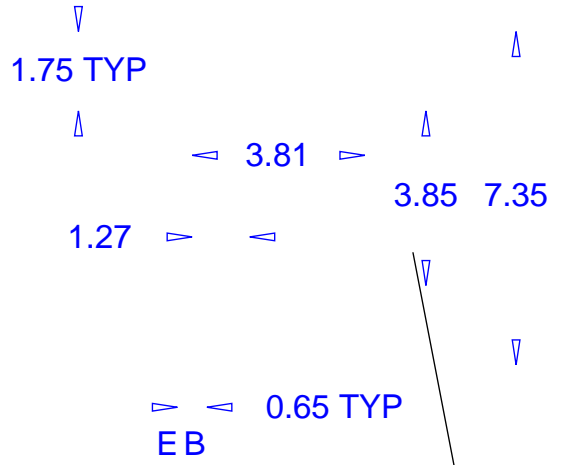
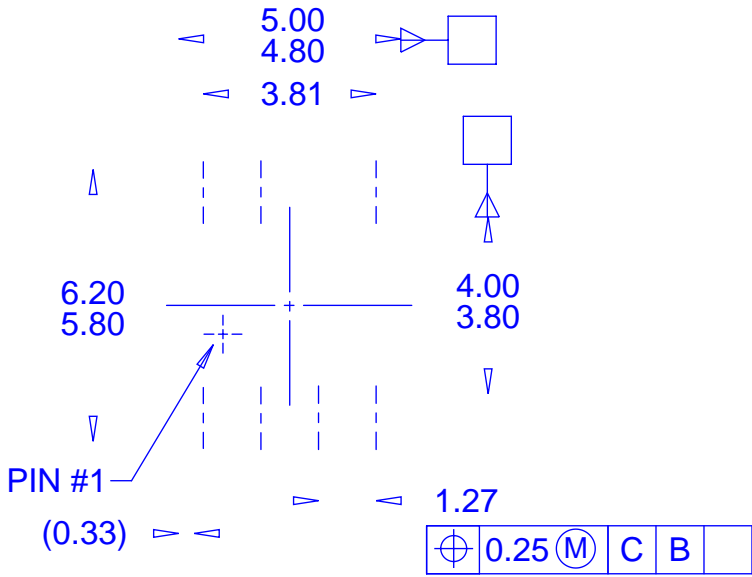
Figure 33. Transformer Specification

Notes:

7. When W4R's winding is reversed winding, it must wind one layer.
8. When W2 is winding, it must wind three layers and put one layer of tape after winding the first layer.

No.	Terminal		Wire	t _s	Insulation	Barrier Tape	
	S	F			t _s	Primary	Seconds
W1	4	5	2UEW 0.23*2	15	2		
W2	3	1	2UEW 0.17*1	41	1		
				39	0		
				37	2		
W3	1	-	COPPER SHIELD	1.2	3		
W4	7	9	TEX-E 0.55*1	9	3		
			CORE ROUNDING TAPE		3		

	Pin	Specification	Remark
Primary-Side Inductance	1 3	2.25 mH ± 7%	100 kHz, 1 V
Primary-Side Effective Leakage	1 3	80 μH ± 5%	Short One of the Secondary Windings



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property